

# **Data sheet**

SAW RF filter GNSS L1/L5

Part number: B8389

Ordering code: B39162B8389P810

Date: November 15, 2022

Version: 2.1

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### 1 Application

- Low insertion attenuation for GNSS system
- Usable pass band 20.46 MHz and 48 MHz

#### 2 Features

- Package size 1.4±0.1 mm × 1.1±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

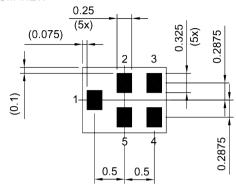


**Figure 1:** Picture of component with example of product marking.

# 3 Package

**Europe GmbH** 

#### **BOTTOM VIEW**



Pad and pitch tolerance ±0.05

# 4 Pin configuration

■ 1 Input

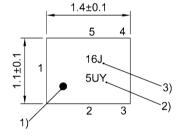
■ 4 Output

■ 2, 3, 5 Ground

SIDE VIEW

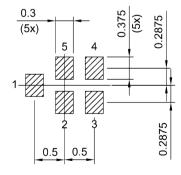






- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

Land pattern THRU VIEW



Landing pad tolerance -0.02

**Figure 2:** Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 19).



# 5 Matching circuit

**Europe GmbH** 

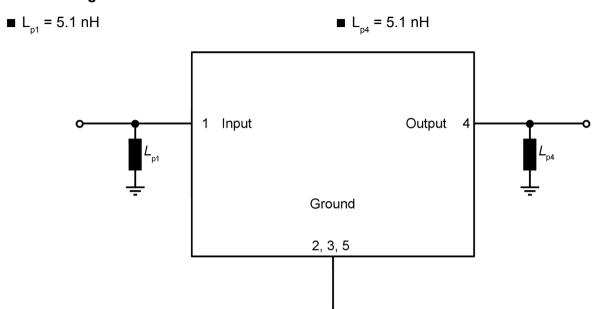


Figure 3: Schematic of matching circuit.



#### 6 Characteristics

**Europe GmbH** 

Temperature range for specification  $T_{\rm SPEC} = -40~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$  Input terminating impedance  $Z_{\rm IN} = 50~\Omega~//~5.1~{\rm nH^{1)}}$  Output terminating impedance  $Z_{\rm OUT} = 50~\Omega~//~5.1~{\rm nH^{1)}}$ 

Characteristics				min.	typ.	max.	
				for $T_{\text{SPEC}}$	@ +25 °C		
Pass band 1							
Center frequency			$f_{_{ m C}}$	_	1176.45	_	MHz
Maximum insertion attenuation			$\alpha_{max}$				
	1166.22 1186.68	MHz		_	1.0	1.6	dB
Amplitude ripple (p-p)			Δα				
	1166.22 1186.68	MHz		_	0.2	0.8	dB
Maximum VSWR			VSWR <sub>max 1</sub>				
@ input port	1166.22 1186.68	MHz		_	1.5	2.2	
@ output port	1166.22 1186.68	MHz		_	1.5	2.2	
Pass band 2							
Center frequency			$f_{_{ m C}}$	_	1583	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	1559 1607	MHz		_	1.8	2.5	dB
Amplitude ripple (p-p)			Δα				
	1559 1607	MHz		_	0.4	1.1	dB
Maximum VSWR			VSWR <sub>max 2</sub>				
@ input port	1559 1607	MHz		_	1.5	2.2	
@ output port	1559 1607	MHz		_	1.5	2.2	
Group delay ripple			$\Delta  au_{ m var}^{2)}$				
	1166.22 1186.68	MHz		_	3	6 <sup>3)</sup>	ns
	1559 1563.2	MHz		_	2	5	ns
	1573.3 1577.5	MHz		_	2.5	6	ns
	1587.6 1591.8	MHz		_	3	6	ns
	1597.6 1605.9	MHz		_	3	8	ns
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 600	MHz		35	39	_	dB
	600 1112	MHz		20	22	_	dB
	1112 1140	MHz		9	11	_	dB
	1215 1235	MHz		10	18	_	dB
	1235 1355	MHz		13	15	_	dB
	1355 1500	MHz		22	25	_	dB
	1650 2000	MHz		204)	27	_	dB
	2000 3000	MHz		24	30	_	dB

See Sec. Matching circuit (p. 6).



2) Aperture of 1 MHz.

**Europe GmbH** 

- 3)
- 5ns for +25°C to +85°C. 24dB for +25°C to +85°C.



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#### 7 **Maximum ratings**

Operable temperature	T <sub>OP</sub> = -40 °C +85 °C	
Storage temperature	T <sub>STG</sub> <sup>1)</sup> = −40 °C +85 °C	
DC voltage	$ V_{DC} ^{2)} = 0 \text{ V}$	
ESD voltage		
	V <sub>ESD</sub> <sup>3)</sup> = 250 V	Human body model.
	V <sub>ESD</sub> <sup>4)</sup> = 125 V	Machine model.
Input power	P <sub>IN</sub>	
@ input port: 1166.22 1186.68 MHz	18 dBm <sup>5), 6)</sup>	Continuous wave for 5000 h @ 55 °C.
@ input port: 1559 1607 MHz	18 dBm <sup>5), 6)</sup>	Continuous wave for 5000 h @ 55 °C.

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C. In case of applied DC voltage blocking capacitors are mandatory.

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. 1)

<sup>2)</sup> 

Expected lifetime according to accelerated power durability simulation, and wear out models.  $T_{\text{SPEC}}$  is the ambient temperature of the PCB at component position. Specified min./max values from section 6 "characteristics" for maximum input power 18dBm are valid for temperature up to 80°C.

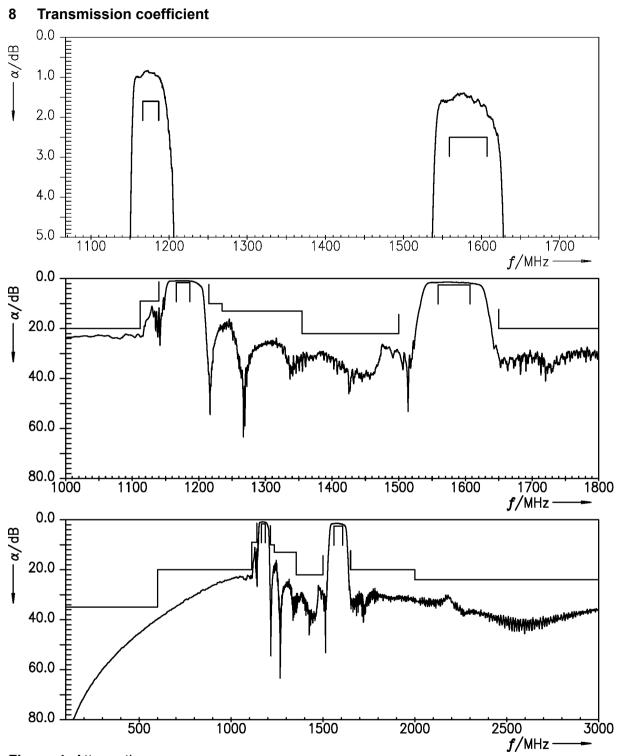
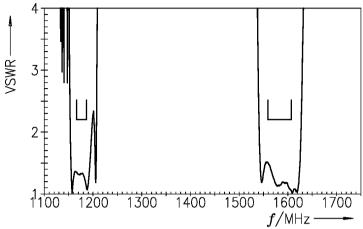


Figure 4: Attenuation.



#### 9 Reflection coefficients



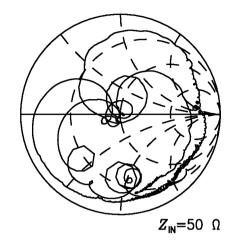
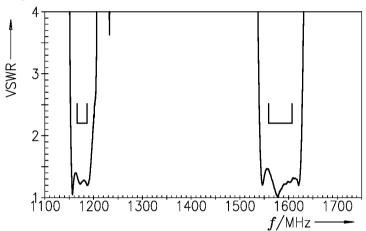


Figure 5: Reflection coefficient at input port.



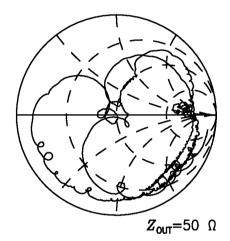


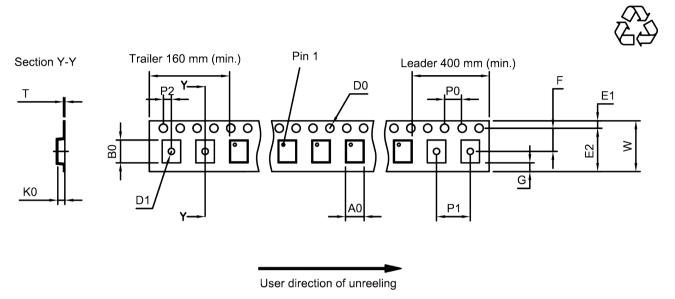
Figure 6: Reflection coefficient at output port.



# 10 Packing material

# 10.1 Tape

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**Figure 7:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A <sub>0</sub>	1.27±0.05 mm	E <sub>2</sub>	6.25 mm (min.)	P <sub>1</sub>	4.0±0.1 mm
B <sub>0</sub>	1.57 <sub>±0.05</sub> mm	F	3.5±0.05 mm	P <sub>2</sub>	2.0±0.05 mm
$D_0$	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.25±0.03 mm
D <sub>1</sub>	0.5 <sub>±0.1</sub> mm	$K_0$	0.62±0.05 mm	W	8.0+0.3/-0.1 mm
E <sub>1</sub>	1.75 <sub>±0.1</sub> mm	P <sub>0</sub>	4.0±0.1 mm		

Table 1: Tape dimensions.

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#### 10.2 Reel with diameter of 180 mm

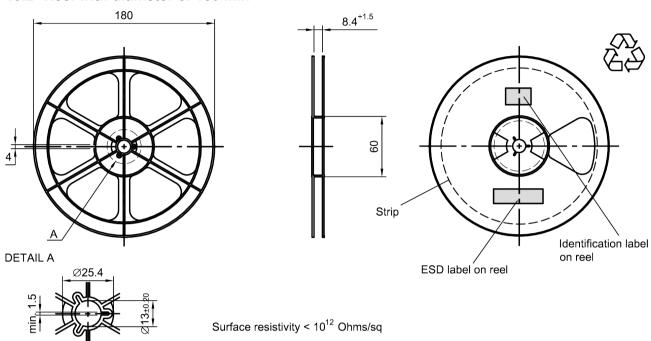


Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.

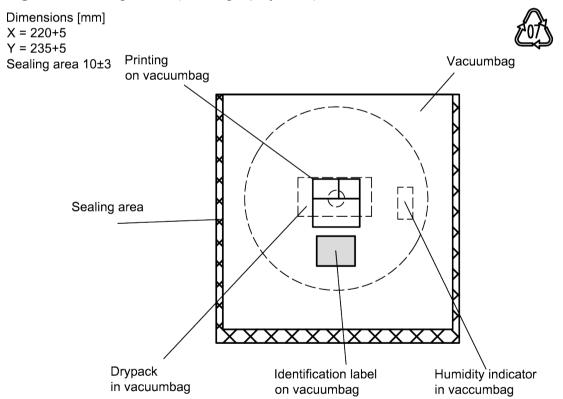


Figure 9: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

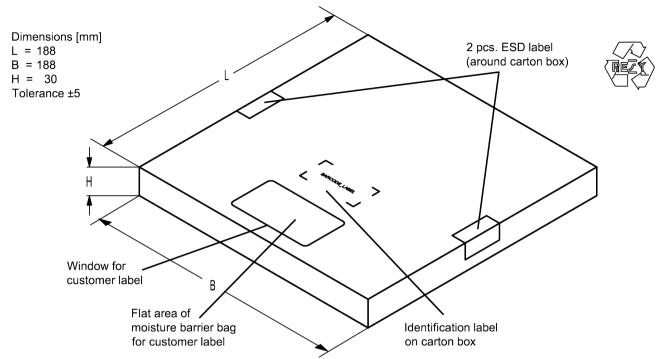


Figure 10: Drawing of folding box for reel with diameter of 180 mm.



#### 11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

#### ■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB1234xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x  $32^2$  + 6 x  $32^1$  + 18 (=J) x  $32^0$  = 1234

The BASE32 code for product type B8389 is 865.

#### ■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345

 $5 \times 47^2 + 27 = (-1) \times 47^1 + 31 = (-1) \times 47^0 = 12345$ 

Adopted BASE32 code for type number					
Decimal	Base32	Decimal	Base32		
value	code	value	code		
0	0	16	G		
1	1	17	Н		
2	2	18	J		
3	3	19	K		
4	4	20	M		
5	5	21	N		
6	6	22	Р		
7	7	23	Q		
8	8	24	R		
9	9	25	S		
10	Α	26	Т		
11	В	27	V		
12	С	28	W		
13	D	29	Х		
14	E	30	Y		
15	F	31	Z		

Adopted BASE47 code for lot number					
Decimal	Base47	Decimal	Base47		
value	code	value	code		
0	0	24	R		
1	1	25	S		
2	2	26	Т		
3	3	27	U		
4	4	28	V		
5	5	29	W		
6	6	30	X		
7	7	31	Y		
8	8	32	Z		
9	9	33	b		
10	Α	34	d		
11	В	35	f		
12	С	36	h		
13	D	37	n		
14	E	38	r		
15	F	39	t		
16	G	40	V		
17	Н	41	\		
18	J	42	?		
19	K	43	{		
20	L	44	}		
21	М	45	<		
22	N	46	>		
23	Р				

**Table 2:** Lists for encoding and decoding of marking.

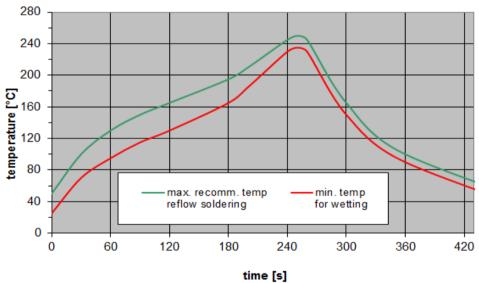


#### 12 Soldering profile

The recommended soldering process is in accordance with IEC  $60068-2-58-3^{rd}$  edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T <sub>peak</sub>	250 °C +0/-5 °C
wetting temperature T <sub>min</sub>	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

**Table 3:** Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 11:** Recommended reflow profile for convection and infrared soldering – lead-free solder.



### 13 ESD protection of acoustic devices

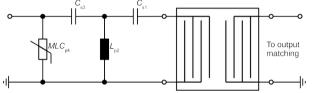
Acoustic devices are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies must be applied.

In general, "ESD matching" must be ensured at that electrical port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the acoustic device must be designed to short circuit or to block the ESD pulse.

Below three figures show recommended "ESD matching" topologies.

For wide band acoustic devices the high-pass ESD matching structure needs to be at least of 3<sup>rd</sup> order to ensure a proper matching for any impedance value of antenna and input port. The required component values must be determined from case to case.



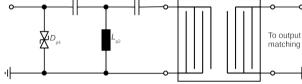
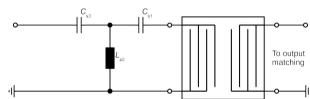


Figure 12: MLC varistor plus ESD matching.

**Figure 13:** Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.



**Figure 14:** 3<sup>rd</sup> order high-pass structure for basic ESD protection.

In all three figures the shunt inductor  $L_{p2}$  could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: **"ESD protection for SAW filters"**. This report can be found under <a href="https://rffe.qualcomm.com">https://rffe.qualcomm.com</a>.



#### 14 Annotations

# 14.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 14.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

#### 14.3 Ordering codes, product IDs, labels, and packing units

Ordering code	Product ID	RF360 label	Packing unit
B39162B8389P810	B39162-B8389-P810-W05	B39162B8389P810W 5	5000 pcs

Table 4: Ordering codes / product IDs and packing units.



#### 15 Cautions and warnings

# 15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <a href="https://rffe.gualcomm.com/">https://rffe.gualcomm.com/</a>.

#### 15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

#### 15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

#### 15.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### **Dimensions**

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

#### **Projection method**

Unless otherwise specified first-angle projection is applied.



#### 16 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
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- 3. The warnings, cautions and product-specific notes must be observed.
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